

COPY OF PAPERS
ORIGINALLY FILED



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

2814
#5A
8/27/02
amr

In re the Application of:

Lamson, et al.

Docket No.: TI-28674

Serial No.: 09/631,198

Examiner: Nguyen, D

Filed: 08/03/00

Art Unit: 2814

For: Structure and Method of High Performance Two Layer Ball Grid Array
Substrate

RECEIVED
AUG 22 2002
TECHNOLOGY CENTER 2800

Amendment under 37 CFR 1.111

Assistant Commissioner of Patents
Washington, DC 20231

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that this correspondence is being deposited with the
U.S. Postal Service as First Class Mail in an envelope addressed to:
Assistant Commissioner for Patents, Washington, D.C. 20231 on

8-5-02

Marianna Smith
Marianna Smith

Dear Sir:

The following amendments and remarks are offered in response to the Examiner's Office Action dated 05/03/02. They are respectfully submitted as a full and complete response to that Action. The Commissioner is hereby requested and authorized to charge any fees necessary for the filing of the enclosed papers to deposit account number 20-0668 of Texas Instruments Incorporated.

Please amend the specification as follows:

In the Claims: